

PRODUCT CHANGE NOTICE (PCN)

SP6685ER-L SP6685ER-L/TR SP6686ER-L SP6686ER-L/TR	PCN No.: 09-00624-01	
	DATE: July 15, 2009	
PART DESCRIPTION: Refer to www.exar.com		
LEVEL OF CHANGE:		
[X] Level I, Customer Approval.	[] Level II, Customer Information.	
PRODUCT ATTRIBUTE AFFECTED:		
[] Material Change[] Design Change[X] Process Change[] Other, Explain:	[X] Data Sheet Change[] Package Change[] Packing / Shipping	
DESCRIPTION OF THE PROPOSED CHANGE:		
Wafer fabrication process flow in Jazz Semiconductor foundry has been modified and two metal masks were revised.		
Applicable datasheets are changed to specify all pins meet ESD-HBM of 2KV except EN pin that meets 1KV.		
There is no change to Form, Fit, or Function as stated in the applicable datasheets except for the ESD rating as stated above.		
REASON FOR CHANGE:		
Process standardization to eliminate product specific flow		
DATE OF SAMPLES AVAILABLE:	DATE OF QUALIFICATION COMPLETED:	
Immediate	June 2009	

PROPRIETARY INFORMATION

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ESTIMATED CHANGE DATE OR DATE CODE:	SUPPORTING DATA:	
August 2009	Reliability Qualification Report	
[X] STANDARD DISTRIBUTION	[] CUSTOM DISTRIBUTION	
PERSON TO CONTACT WITH QUESTIONS:		
Lisa Bedard Exar Corporation 1 Holiday Avenue West Tower, Suite 450 Pointe-Claire, Quebec H9R 5N3 Tel: (514) 429-1010 ext 210 Fax: (514) 695-2548		
Please acknowledge receipt of this PCN.		
Acknowledged:		
Signature		
Printed Name		
Company		
Title		
Date		
Approved		
Comments:		

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